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INTERNATIONAL CONFERENCE ON
SOLID STATE
DEVICES AND MATERIALS

2008 International Conference on
Solid State Devices and Materials (SSDM 2008)

SECRETARIAT

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CONFERENCE THEME

“Device and Material Innovations
for Novel System Integration”

Conference

Short Course & Special Events

Place

September 24-26, 2008

September 23, 2008

Tsukuba International
Congress Center (Tsukuba, Ibaraki, Japan)

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